

Product Change Notification

PCN No: PCN_CC2400_001_rev02		Chipcon Product Name: CC2400	
Data sheet reference: CC2400 Data Sheet rev.1.3	Customer reference: NA	Date: 2005-01-06	
Description of change: Production of CC2400 has until today been packed in a QLP48 package. Due to a change of supplier the CC2400 will be packed in a QFN48 package. The QFN48 packages are available in both standard lead finish package and "lead free" package compliant with European regulations, ref. " DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment RoHS". For ordering details please consult datasheet rev. 1.3.			
Reason for change: Change package supplier.			
Consequence of change: No change in electrical performance. I.e. same data sheet parameters as before. The pin size/format of the new QFN48 package is slightly different than of the QLP48 and customers not following the recommended PCB layout may need to change their footprint. For more information, please consult datasheet rev. 1.3.			
Verification: First Article Inspection has been performed by Chipcon to verify that the electrical performance is in accordance with the product data sheet.			
Change active from (date): To be advised in Chipcon Order Confirmation as a response to customer purchase orders		Change active from (date code & lot code): Date code 0425 Lot code. WB4564	
Last time order (date): NA		Last shipment date: NA	
Document history:			
Revision:	Date:	Description/Change:	
02	2005-01-06	Clarification in section Consequence of change.	
01	2004-11-05	Initial release	
Approval / Date : ARK / 2005-01-06		Signature : Arne Kjensmo, VP Operations	

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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